

SEMIKRON SKYPER 32 R Gate Driver Board Owner's Manual

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OWNER'S MANUAL

Technical Explanation

Board 3s SKYPER® 32 R

• Revision: 05

Issue date: 2016-03-16Prepared by: H.FlohrerApproved by: J.Krapp

Keyword: IGBT Driver, Adapter Board SKYPER

Please note:

All values in this technical explanation are typical values. Typical values are the average values expected in large quantities and are provided for information purposes only. These values can and do vary in different applications. All operating parameters should be validated by user's technical experts for each application.

1. Application and Handling Instructions

- Please provide for static discharge protection during handling. As long as the hybrid driver is not completely
 assembled, the input terminals have to be short-circuited. Persons working with devices have to wear a
 grounded bracelet. Any synthetic floor coverings must not be statically chargeable. Even during transportation
 the input terminals have to be short-circuited using, for example, conductive rubber. Worktables have to be
 grounded. The same safety requirements apply to MOSFET- and IGBT-modules.
- Any parasitic inductances within the DC-link have to be minimised. Over-voltages may be absorbed by C- or RCD-snubber networks between main terminals for PLUS and MINUS of the power module.
- When first operating a newly developed circuit, SEMIKRON recommends to apply low collector voltage and load current in the beginning and to increase these values gradually, observing the turn-off behaviour of the free-wheeling diode and the turn-off voltage spikes generated across the IGBT. An oscillographic control will be necessary. Additionally, the case temperature of the module has to be monitored. When the circuit works correctly under rated operation conditions, short-circuit testing may be done, starting again with low collector voltage.

- It is important to feed any errors back to the control circuit and to switch off the device immediately in failure events. Repeated turn-on of the IGBT into a short circuit with a high frequency may destroy the device.
- The inputs of the hybrid driver are sensitive to over-voltage. Voltages higher than VS +0,3V or below -0,3V may destroy these inputs. Therefore, control signal over-voltages exceeding the above values have to be avoided.
- The connecting leads between hybrid driver and the power module should be as short as possible (max. 20cm), the driver leads should be twisted.

2. Further application support

Latest information is available at http://www.semikron.com. For design support please read the SEMIKRON Application Manual Power Modules available at http://www.semikron.com.

3. General Description

The Board 3s SKYPER® 32 R is an adaptor board for the IGBT module SEMiX® 3s (spring contact version). The board can be customized allowing adaptation and optimization to the used SEMiX® Module.

he switching characteristic of the IGBT can be influenced through user settings, e.g. changing turn-on and turn-off speed by variation of RGon and RGoff. Furthermore, it is possible to adjust the monitoring level and blanking time for the DSCP (see Technical Explanations SKYPER® 32 R).

Please note:

This technical explanation is based on the Technical Explanations for SKYPER® 32 R. Please read the Technical Explanations SKYPER® 32 R before using the Adaptor Board.

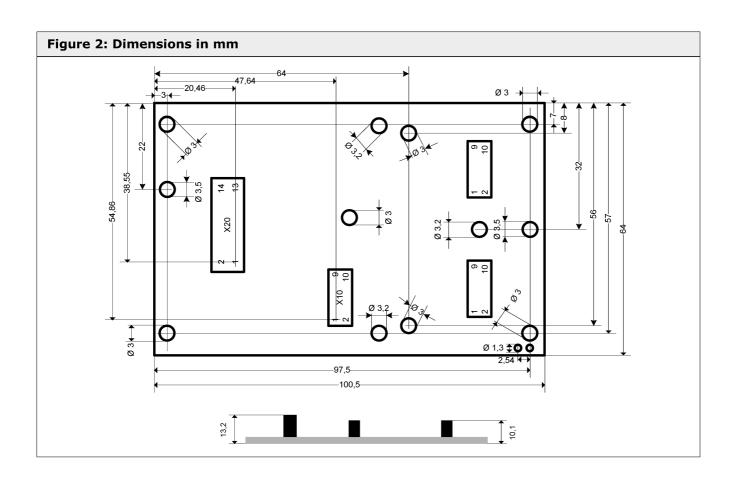
Figure 1: Board 3s SKYPER® 32 R



4. Quality

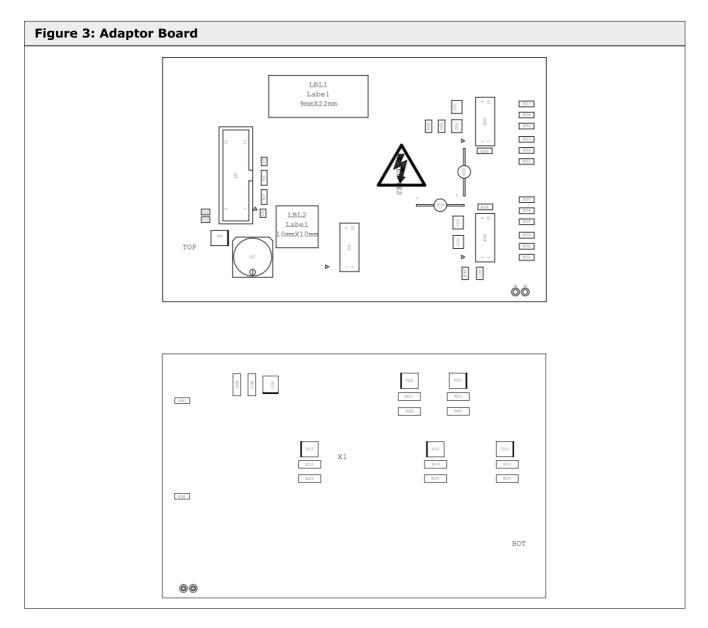
Table 1: Quality				
End test	test category	test describtion	standard	
AOI	Automated Optical Inspection	Control of accurate placement of components/ of solder joints	SEMIKRON	
ICT	In-Circuit Test	Test of the populated PCB, checking the correctly fabrication	SEMIKRON	
Type test	test category	test conditions	standard	
EP	Electrical Parameters	Jamb = -40°C / +85°C	SEMIKRON	
SP	STEP Test, Interrupted PS	20x 10μs to 2s	EN61000-4-29	
Iso	Isolation Test	High voltage test 4kV, 60s	EN 61800-5-1	
тс	Thermal Cycling	200 cycles, Tstgmax – Tstgmin	IEC60068-2-14	
PD	Partial discharge test	>1,2 kV; suitable for 1000V DC Link	VDE 0110-20	
ТН	Temperature Humidity	85°C, 85% RH, 96h	IEC 60068-2-67	
VB	Vibration	Sinus 20/2000Hz Random 10/2000Hz, 5g, 26 per x,y,z	IEC 60068-2-6	
SH	Shock	Half-sinus pulse, 30g, 6000 shocks, 6ms, $\pm x$, $\pm y$, $\pm z$	IEC 60068-2-29	

5. Dimensions

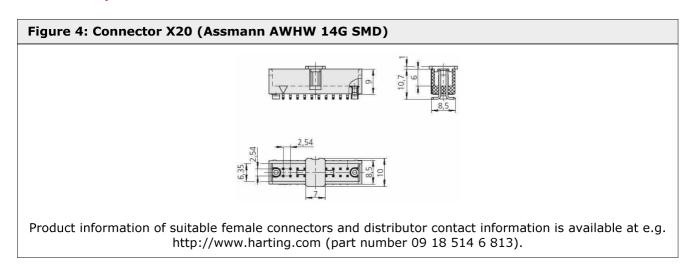


6. Component Placement Layout

7. PIN Array



7. PIN Array



Product information of suitable female connectors and distributor contact information is available at e.g.

Table 2: PIN Array				
PIN	Signal	Function	Specification	
X20:01	reserved			
X20:02	IF_HB_BOT	Switching signal input (BOTTOM switch)	Digital 15 V; 10 kOhm impedance; LOW = BOT switch off; HIGH = BOT switch on	
X20:03	IF_nERROR_OUT	ERROR output	LOW = NO ERROR; open collector output; max. 30V / 15mA (external pull up resistor necessary)	
X20:04	IF_HB_TOP	Switching signal input (TOP switch)	Digital 15 V; 10 kOhm impedance; LOW = TOP switch off; HIGH = TOP switch on	
X20:05	reserved			
X20:06	reserved			
X20:07	reserved			
X20:08	IF_PWR_15P	Drive power supply	Stabilised +15V ±4%	
X20:09	IF_PWR_15P	Drive power supply	Stabilised +15V ±4%	
X20:10	IF_PWR_GND	GND for power supply and GND for digital signals		
X20:11	IF_PWR_GND	GND for power supply and GND for digital signals		
X20:12	reserved			
X20:13	reserved			
X20:14	reserved			

Please note:

The feature PRIM_ERROR_IN of the driver core is not availble at the interface X20.

8. Setting Dynamic Short Circuit Protection

Table 3: R _{CE} & C _{CE}			
Designation	Pattern Name	Setting	
R160	1206	R _{CE} Factory setting: not equipped	ТОР
C150	1206	C _{CE} Factory setting: not equipped	ТОР
R260	1206	R _{CE} Factory setting: not equipped	ВОТ
C250	1206	C _{CE} Factory setting: not equipped	ВОТ

9. Collector Series Resistance

Table 4: R _{VCE}			
Designation	Pattern Name	Setting	
R150	MiniMELF	R _{VCE} * Factory setting: not equipped	ТОР
R250	MiniMELF	R _{VCE} * Factory setting: not equipped	ВОТ

* 1200V IGBT operation: $0\Omega\,$

1700V IGBT operation: $1k\Omega$ / 0,4W

10. Adaptation Gate Resistors

Table 5: R _{Gon} & R _{Goff}			
Designation	Pattern Name	Setting	
R151, R152, R153 (parallel connected)	MiniMELF	R _{Gon} Factory setting: not equipped	ТОР
R155, R156, R157 (parallel connected)	MiniMELF	R _{Goff} Factory setting: not equipped	ТОР
R251, R252, R253 (parallel connected)	MiniMELF	R _{Gon} Factory setting: not equipped	вот
R255, R256, R257 (parallel connected)	MiniMELF	R _{Goff} Factory setting: not equipped	вот

11. Adaptation Decoupling Gate Resistors

For details to the decoupling gate resistors and recommended values, see Modules Explanations and Data Sheets SEMiX®.

12. Boost Capacitors

Table 6: R _{G1} , R _{G2} , R _{G3}			
Designation	Pattern Name	Setting	
R101	MELF	R _{G1} Factory setting: not equipped	ТОР
R102	MELF	R _{G2} Factory setting: not equipped	ТОР
R103	MELF	R _{G3} Factory setting: not equipped	ТОР
R201	MELF	R _{G1} Factory setting: not equipped	ВОТ
R202	MELF	R _{G2} Factory setting: not equipped	ВОТ
R203	MELF	R _{G3} Factory setting: not equipped	ВОТ

12. Boost Capacitors

Table 7: C _{boost15P} & C _{boost8N}			
Designation	Pattern Name	Setting	
C151	1210	C _{boost8N} Factory setting: 4,7µF/16V *	ТОР
C152	1210	C _{boost15P} Factory setting: 2,2µF/25V *	ТОР
C251	1210	C _{boost8N} Factory setting: 4,7µF/16V *	ВОТ
C252	1210	C _{boost15P} Factory setting: 2,2µF/25V *	ВОТ

^{*} output charge pulse: 5µC

13. Temperature Signal

The temperature sensor inside the SEMiX® module is directly connected to contacting points T1 and T2. For details to the temperature sensor, see Modules Explanations SEMiX®.

Safety Warnings:

The contacting points T1 and T2 are not electrical isolated. Due to high voltage that may be present at the contacting points T1 and T2, some care must be taken in order to avoid accident. There is no cover or potential isolation that protect the high voltage sections / wires from accidental human contact.

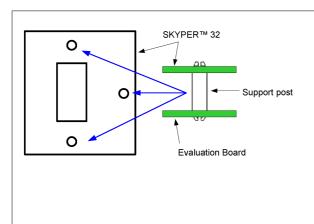
14. Mounting Notes

The electrical connections between adaptor board and SEMiX® are realised via spring contacts integrated in SEMiX® power modules and via landing pads on the bottom side of the adaptor board.

Figure 5: Adaptor Board & Driver Core Mounting



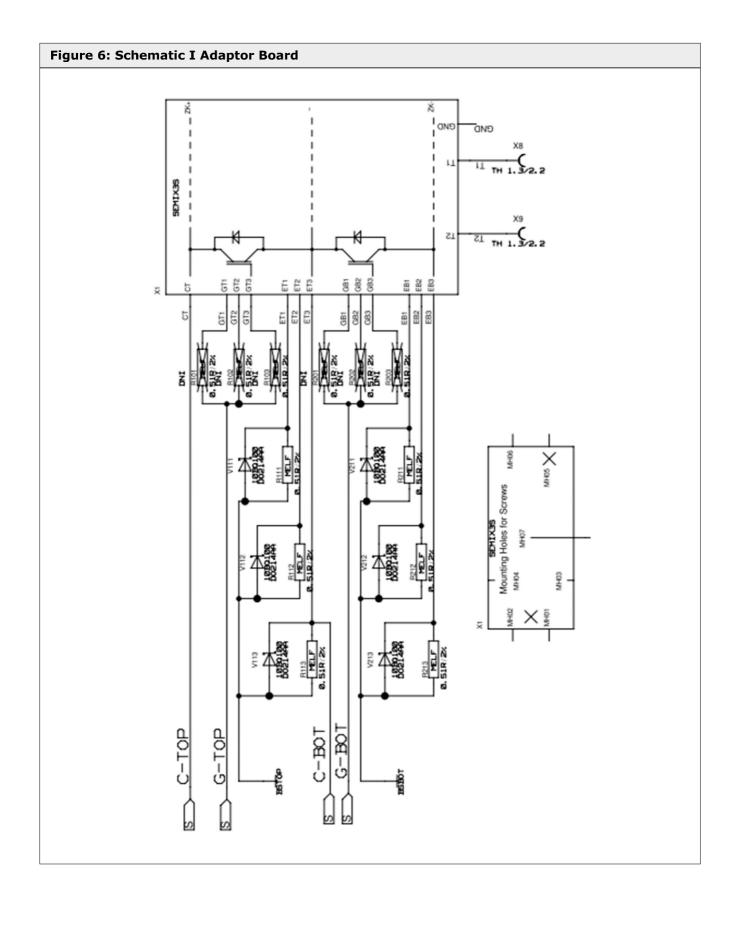
- [1] Soldering of components (e.g. R_{Gon} , R_{Goff} , etc.) on adapter board.
- [2] Adaptor Board has to be fixed to the SEMiX® module (see "Mounting Instruction and Application Notes for SEMiX® IGBT modules" on SEMiX® product overview page at http://www.semikron.com).
- [3] Insert driver core into the box connector on adaptor board.



The connection between driver core and adaptor board should be mechanical reinforced by using support posts. The posts have to be spaced between driver core and adaptor board.

Product information of suitable support posts and distributor contact information is available at e.g. http://www.richco-inc.com (e.g. part number DLMSPM-8-01, LCBST-8-01).

15. Schematics



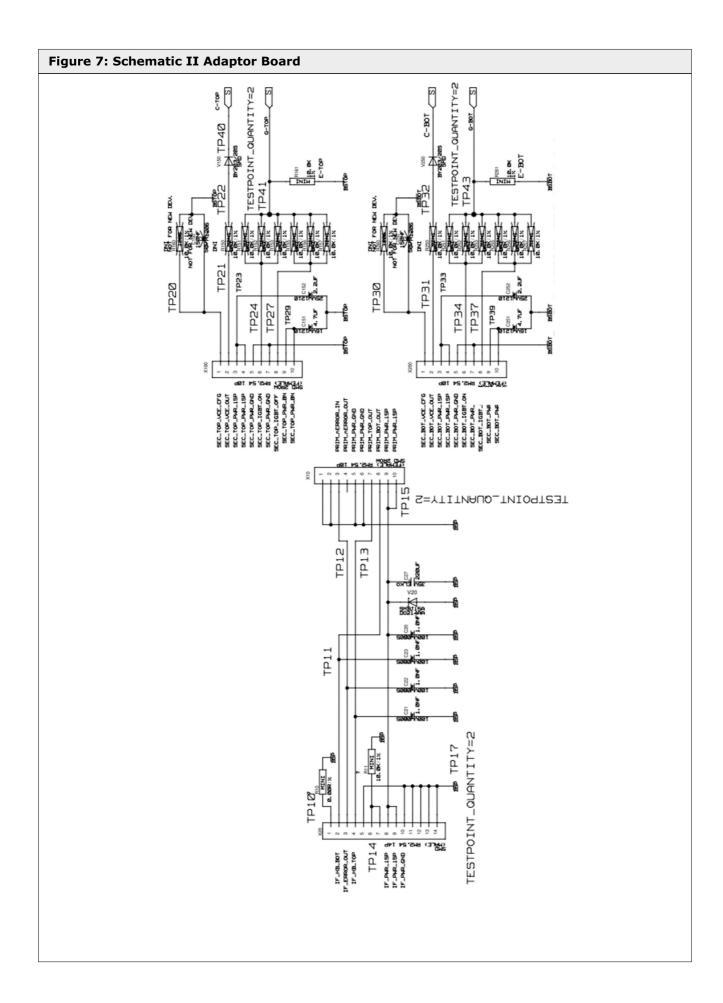


Figure 8: Parts List Adaptor Board

Count	Ref. Designator	Value	Pattern Name	Description
2	C151, C251	4,7μF	1210 (SMD)	Capacitor X7R
2	C152, C252	2,2μF	1210 (SMD)	Capacitor X7R
4	C20, C21, C22, C23	1nF	0805 (SMD)	Capacitor X7R
1	C27	220uF/35V	SMD	Longlife-Elko
1	R10	0,00Ohm	MiniMelf (SMD)	
3	R11, R161, R261	10,0KOhm	MiniMelf (SMD)	1%
6	R111, R112, R113, R211, R212, R213	0,51Ohm	Melf (SMD)	2%
6	V111, V112, V113, V211, V212, V213	10BQ100N	DO214AA (SMD)	Diode Schottky
2	V150, V250	BY203/20S		High Voltage Diode
1	V20	SMBJ15A	DO215AA (SMD)	Suppressor Diode
3	X10, X100, X200	RM2,54 10p.	SMD	Box Connector
1	X20	14p.	SMD	Connector

TP: Test Point

Box Connector: SUYIN 254100FA010G200ZU

References

[1] www.SEMIKRON.com

[2] A. Wintrich, U. Nicolai, W. Tursky, T. Reimann, "Application Manual Power Semiconductors", ISLE Verlag 2011, ISBN 978-3-938843-666

HISTORY

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Specifications

Product: IGBT Driver Adapter Board SKYPER

· Revision: 32 R

Issue date: 2016-03-16Prepared by: H.FlohrerApproved by: J.Krapp

FAQ

Q: Where can I find product information of suitable female connectors?

A: Product information of suitable female connectors and distributor contact information is available at http://www.harting.com (part number 09 18514 6 813).

Q: What are the quality standards for the product?

A: The product undergoes various quality tests including Automated Optical Inspection, In-Circuit Test, Electrical Parameters Test, Thermal Cycling Test, and more as per SEMIKRON standards.

Documents / Resources



<u>SEMIKRON SKYPER 32 R Gate Driver Board</u> [pdf] Owner's Manual SKYPER 32 R Gate Driver Board, SKYPER 32 R, Gate Driver Board, Driver Board, Board

References

- <u>Swe are the Ultimate Partner in Power Electronics | Semikron Danfoss</u>
- User Manual

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